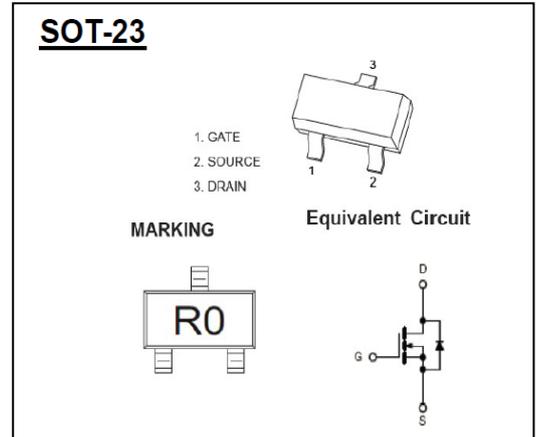


●N-Channel Enhancement Mode Field Effect MOSFET

特性: Features

- High dense cell design for extremely low RDS(on).
- Exceptional on-resistance and maximum DC current capability.
- Load/Power Switching.
- Interfacing Switching

V(BR)DSS	RDS(ON)MAX	ID
30V	35mΩ@10V	5.8A
	40mΩ@4.5V	
	52mΩ@2.5V	



极限值和温度特性(TA = 25°C 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current	I _D	5.8	A
Drain Current-Pulsed(note 1)	I _{DM}	30	
Power Dissipation	P _D	350	mW
Junction Temperature	T _J	150	°C
Storage Temperature	T _{stg}	-50-+150	°C
Thermal Resistance From Junction to Ambient (note 2)	R _{θJA}	357	°C/W

电特性 (TA = 25°C 除非另有规定)

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameter	符号 Symbols	测试条件 Test Condition	界限 Limits			单位 Unit
			Min	Typ	Max	
Off characteristics						
Drain-Source Breakdown Voltage	V(BR)DSS	VGS=0V, ID=250uA	30			V
Zero Gate Voltage Drain current	IDSS	VDS=24V, VGS=0V			1	uA
Gate-body Leakage	IGSS	VDS=12V, VDS=0V			±100	nA
On characteristics						
Drain-Source On-Resistance (note 3)	RDS(ON)	VGS=10V, ID=5.8A			35	mΩ
		VGS=4.5V, ID=5A			40	
		VGS=2.5V, ID=4A			52	
Forward trans conductance	gfs	VDS=5V, ID=5A	8			S
Gate-Threshold voltage*	VGS(th)	VDS=VGS, ID=250uA	0.7		1.4	V
Dynamic characteristics (note 4,5)						
Input capacitance	Ciss	VDS=15V, VGS=0V, f=1MHz			1050	pF
Output capacitance	Coss			99		
Reverse Transfer capacitance	Crss			77		
Gate resistance	Rg	VDS=0V, VGS=0V, f=1MHz			3.6	Ω
Switching characteristics (note 4,5)						
Turn-on Time	td(on)	VGS=10V, RL=2.7Ω, VDS=15V, RGEN=3Ω			5	ns
Rise time	tr				7	
Turn-off Time	td(off)				40	
Fall time	tf				6	
Diode forward voltage and maximum ratings						
Diode forward voltage	VSD	IS=1A, VGS=0V			1.0	V

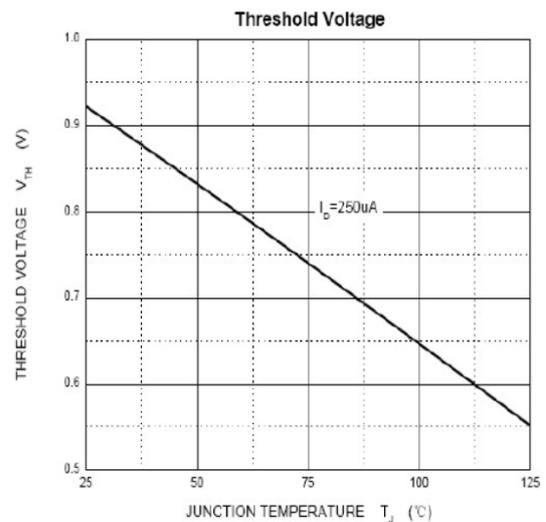
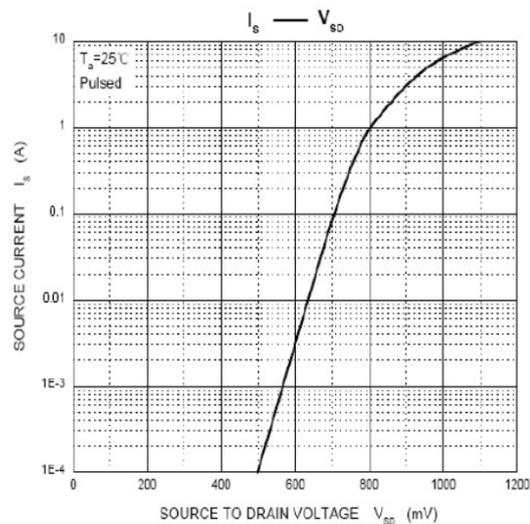
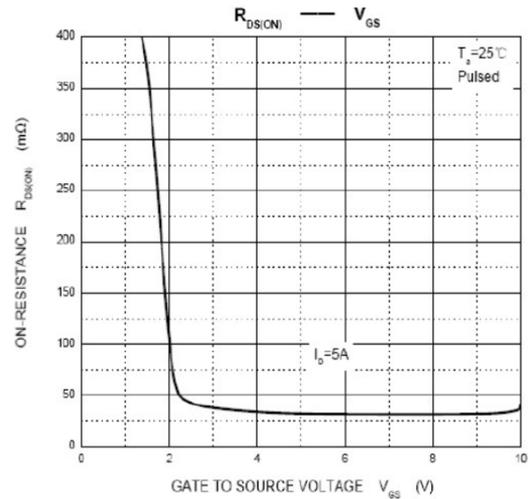
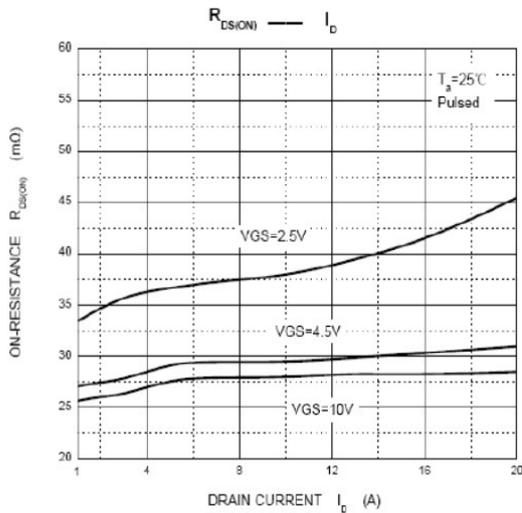
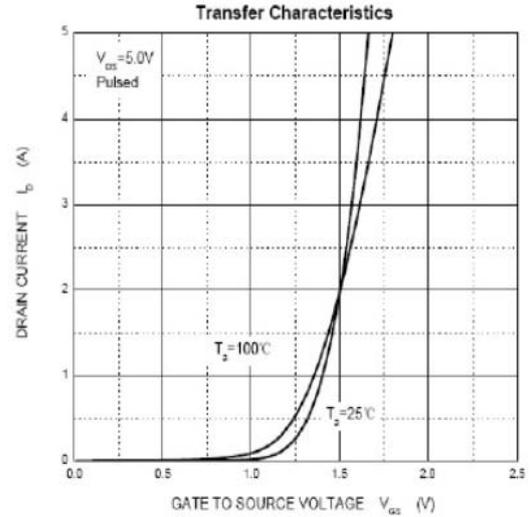
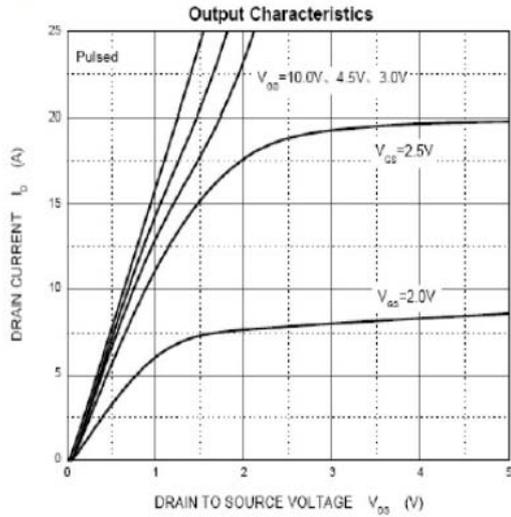
Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t<5 sec.

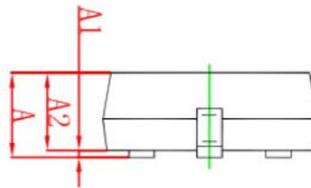
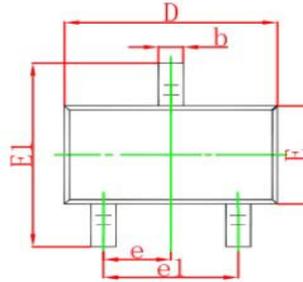
3. Pulse Test: Pulse Width ≤300us, Duty Cycles≤2%.

4. Guaranteed by design, not subject to production testing.

Typical characteristics



DIMENSION SOT-23 外形封装尺寸



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°